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Title of Invention: TRANSFER MOLD SOLUTION FOR  
MOLDED MULTI-MEDIA CARD  
First Named Inventor: DAVID CHUN  
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Electronic Version v1.1  
Stylesheet Version v1.1.0

Title of Invention	TRANSFER MOLD SOLUTION FOR MOLDED MULTI-MEDIA CARD									
Application Number: 10/824999 										
Date: 2004-04-15										
First Named Applicant: DAVID DOSUNG										
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MARK B. GARRED Registered Number: 34,823	/mbg/	Attorney								
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	us-ids.dtd									
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Electronic Version v18  
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Title of Invention	TRANSFER MOLD SOLUTION FOR MOLDED MULTI-MEDIA CARD
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Application Number: 10/824999  
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First Named Applicant: DAVID CHUN  
Attorney Docket Number: AMKOR103A  
Art Unit: 2833



Search string: ( 5216278 or 5218231 or 5221642 or 5250841  
or 5252853 or 5258094 or 5266834 or 5273938  
or 5277972 or 5278446 or 5279029 or 5281849  
or 5294897 or 5327008 or 5332864 or 5335771  
or 5336931 or 5343076 or 5358905 or 5365106  
or 5381042 or 5391439 or 5406124 or 5410180  
or 5414299 or 5417905 or 5424576 or 5428248  
or 5435057 or 5444301 or 5452511 or 5454905  
or 5474958 or 5484274 or 5493151 or 5508556  
or 5517056 or 5521429 or 5528076 or 5534467  
or 5539251 or 5543657 or 5544412 or 5545923  
or 5581122 or 5592019 or 5592025 or 5594274  
or 5595934 or 5604376 ).pn.

US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
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Signature

Examiner Name	Date